507603117 11/17/2022

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT7650008

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT OF SECURITY INTEREST IN PATENT COLLATERAL	

CONVEYING PARTY DATA

Name	Execution Date
BARCLAYS BANK PLC	11/15/2022

RECEIVING PARTY DATA

Name:	CITIBANK, N.A.	
Street Address:	388 GREENWICH STREET	
Internal Address:	7TH FLOOR	
City:	NEW YORK	
State/Country:	NEW YORK	
Postal Code:	10013	

PROPERTY NUMBERS Total: 442

Property Type	Number
Application Number:	10271511
Application Number:	15265385
Application Number:	15286759
Application Number:	15302712
Application Number:	15326224
Application Number:	15326180
Application Number:	15318829
Application Number:	13168465
Application Number:	15439555
Application Number:	11857871
Application Number:	15716963
Application Number:	14386601
Application Number:	15390861
Application Number:	14908986
Application Number:	15109352
Application Number:	14915067
Application Number:	15028988
Application Number:	15549535
Application Number:	15316684

PATENT REEL: 061956 FRAME: 0643

507603117

Property Type	Number
Application Number:	15426320
Application Number:	15148320
Application Number:	12567523
Application Number:	14058553
Application Number:	15644331
Application Number:	16003202
Application Number:	14900493
Application Number:	14909888
Application Number:	62655409
Application Number:	62689962
Application Number:	10036952
Application Number:	09067381
Application Number:	09231490
Application Number:	09266166
Application Number:	09266232
Application Number:	09282729
Application Number:	09345675
Application Number:	09395553
Application Number:	09395558
Application Number:	09728264
Application Number:	09834196
Application Number:	10151741
Application Number:	10363420
Application Number:	10458925
Application Number:	10722288
Application Number:	10817138
Application Number:	10888286
Application Number:	10888619
Application Number:	10899679
Application Number:	10911908
Application Number:	11012457
Application Number:	15318895
Application Number:	15312799
Application Number:	15302827
Application Number:	14878056
Application Number:	14698450
Application Number:	14438888
Application Number:	14434470

Property Type	Number
Application Number:	14347035
Application Number:	14236480
Application Number:	14236432
Application Number:	14095559
Application Number:	14027530
Application Number:	13287820
Application Number:	12497065
Application Number:	13471203
Application Number:	13655159
Application Number:	14077995
Application Number:	12052104
Application Number:	11720578
Application Number:	12036497
Application Number:	11857818
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Application Number:	12175381
Application Number:	12191691
Application Number:	12036604
Application Number:	11462089
Application Number:	12201654
Application Number:	11419128
Application Number:	11682729
Application Number:	12191710
Application Number:	11065764
Application Number:	11873838
Application Number:	15545607
Application Number:	15562195
Application Number:	15017975
Application Number:	15419564
Application Number:	62785293
Application Number:	09274641
Application Number:	09421204
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Application Number:	10090048
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Application Number:	09677904
Application Number:	09672577

Property Type	Number
Application Number:	09687880
Application Number:	09949191
Application Number:	09710976
Application Number:	09718910
Application Number:	09965743
Application Number:	09784242
Application Number:	10419651
Application Number:	09788766
Application Number:	09802087
Application Number:	09803631
Application Number:	09906370
Application Number:	10328197
Application Number:	09945011
Application Number:	09938234
Application Number:	09946404
Application Number:	10096411
Application Number:	10076897
Application Number:	10106522
Application Number:	10271817
Application Number:	10372747
Application Number:	10412932
Application Number:	10431251
Application Number:	10820236
Application Number:	10694375
Application Number:	10705026
Application Number:	10798522
Application Number:	10837109
Application Number:	11205516
Application Number:	11209471
Application Number:	11290118
Application Number:	11316010
Application Number:	11893068
Application Number:	11403628
Application Number:	11398048
Application Number:	11503780
Application Number:	11796660
Application Number:	11728757
Application Number:	11821206

Property Type	Number
Application Number:	12350380
Application Number:	12156613
Application Number:	12244136
Application Number:	12261352
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Application Number:	12409629
Application Number:	15678771
Application Number:	12488158
Application Number:	12509619
Application Number:	12573298
Application Number:	13681722
Application Number:	12549547
Application Number:	13188615
Application Number:	12697425
Application Number:	13741446
Application Number:	12693548
Application Number:	14181866
Application Number:	13238832
Application Number:	12890013
Application Number:	13593690
Application Number:	12940249
Application Number:	12947059
Application Number:	13021026
Application Number:	13954328
Application Number:	13018668
Application Number:	13398111
Application Number:	14467105
Application Number:	15357385
Application Number:	13677798
Application Number:	13356004
Application Number:	13795382
Application Number:	15934127
Application Number:	13480887
Application Number:	13870232
Application Number:	13961018
Application Number:	14293216
Application Number:	10333484
Application Number:	10470792

Property Type	Number
Application Number:	14204241
Application Number:	14200546
Application Number:	14294437
Application Number:	14454131
Application Number:	14870738
Application Number:	15134469
Application Number:	15405417
Application Number:	14831403
Application Number:	14831266
Application Number:	13786728
Application Number:	13609705
Application Number:	13568277
Application Number:	13438149
Application Number:	13398242
Application Number:	13353428
Application Number:	09183137
Application Number:	09620884
Application Number:	09143427
Application Number:	09051784
Application Number:	09603978
Application Number:	09147972
Application Number:	09598857
Application Number:	10190873
Application Number:	10925589
Application Number:	10304514
Application Number:	10964212
Application Number:	11348941
Application Number:	10943113
Application Number:	11300254
Application Number:	11386631
Application Number:	12046864
Application Number:	12436260
Application Number:	09260925
Application Number:	15551052
Application Number:	15762599
Application Number:	15754224
Application Number:	15765637
Application Number:	15616540

Property Type	Number
Application Number:	15641756
Application Number:	15617482
Application Number:	15412809
Application Number:	15739314
Application Number:	14666990
Application Number:	11243631
Application Number:	11243624
Application Number:	11766642
Application Number:	14702020
Application Number:	13882330
Application Number:	15148738
Application Number:	14916706
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Application Number:	14893854
Application Number:	15545208
Application Number:	15607925
Application Number:	15717275
Application Number:	15973814
Application Number:	16059086
Application Number:	15977526
Application Number:	11423474
Application Number:	12278256
Application Number:	12665908
Application Number:	13003398
Application Number:	13125622
Application Number:	13638442
Application Number:	13699910
Application Number:	13981974
Application Number:	14001360
Application Number:	14234080
Application Number:	14776879
Application Number:	15037267
Application Number:	15291340
Application Number:	09046869
Application Number:	08963999
Application Number:	09394839
Application Number:	09403900
Application Number:	08939656

Property Type	Number
Application Number:	09383718
Application Number:	09463453
Application Number:	09786300
Application Number:	09831008
Application Number:	10092976
Application Number:	09716975
Application Number:	10148090
Application Number:	10129998
Application Number:	10169959
Application Number:	10118417
Application Number:	10358596
Application Number:	10619198
Application Number:	10867346
Application Number:	11272999
Application Number:	10091106
Application Number:	11085304
Application Number:	11852513
Application Number:	11230912
Application Number:	11102038
Application Number:	11554100
Application Number:	11243876
Application Number:	11279512
Application Number:	12185641
Application Number:	11759456
Application Number:	11549775
Application Number:	11463355
Application Number:	11620857
Application Number:	11756048
Application Number:	11846385
Application Number:	11420339
Application Number:	10678601
Application Number:	11736647
Application Number:	12446176
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Application Number:	12238139
Application Number:	10963369
Application Number:	11039088
Application Number:	11759624

Property Type	Number
Application Number:	12168680
Application Number:	11563335
Application Number:	12268144
Application Number:	12254207
Application Number:	12617202
Application Number:	10902398
Application Number:	12440355
Application Number:	12324335
Application Number:	11778011
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Application Number:	13176411
Application Number:	12596559
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Application Number:	13054048
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Application Number:	14630268
Application Number:	13558019
Application Number:	14108954
Application Number:	14350971
Application Number:	13636087
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Application Number:	16201092
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Application Number:	14325601
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Application Number:	15667002
Application Number:	09744824
Application Number:	09415811

Property Type	Number
Application Number:	10752484
Application Number:	09507840
Application Number:	10754297
Application Number:	10853342
Application Number:	10891351
Application Number:	10811763
Application Number:	10837107
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Application Number:	12620715
Application Number:	12413753
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Application Number:	12367650
Application Number:	15638878
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Application Number:	14315883
Application Number:	12826773
Application Number:	14136547
Application Number:	13030810
Application Number:	13169296

Property Type	Number
Application Number:	14081200
Application Number:	13182533
Application Number:	13205107
Application Number:	13355769
Application Number:	14016443
Application Number:	13091466
Application Number:	13183558
Application Number:	13372060
Application Number:	14302512
Application Number:	13595473
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Application Number:	13477556
Application Number:	14328857
Application Number:	15086402
Application Number:	13591375
Application Number:	13892406
Application Number:	13965537
Application Number:	14160799
Application Number:	14458659
Application Number:	14183948
Application Number:	14539171
Application Number:	14693062
Application Number:	14830833
Application Number:	14829163
Application Number:	15040617
Application Number:	15493498
Application Number:	14935963
Application Number:	15067622
Application Number:	15485504
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Application Number:	15484314
Application Number:	15590068
Application Number:	09898152
Application Number:	09921589
Application Number:	10153946
Application Number:	10105898
Application Number:	10768799

Property Type	Number
Application Number:	09535353
Application Number:	09417043
Application Number:	15608210
Application Number:	15463379
Application Number:	15463341
Application Number:	15224979
Application Number:	14985638
Application Number:	14937267
Application Number:	14191529
Application Number:	13653916
Application Number:	12939388
Application Number:	12348981
Application Number:	12267642
Application Number:	15485336
Application Number:	10946937
Application Number:	15145230
Application Number:	14017786
Application Number:	13044613
Application Number:	14157928
Application Number:	12173284
Application Number:	12549579
Application Number:	12469337
Application Number:	14041669
Application Number:	13475030
Application Number:	13463087
Application Number:	13463110
Application Number:	09251641
Application Number:	10341859
Application Number:	13371848
Application Number:	10456329
Application Number:	09698370
Application Number:	09821205
Application Number:	90012575
Application Number:	12858887
Application Number:	09823904
Application Number:	10386315
Application Number:	09382214
Application Number:	09624104

Property Type	Number
Application Number:	10462977
Application Number:	11267435
Application Number:	10805769
Application Number:	10970881
Application Number:	12037429

CORRESPONDENCE DATA

Fax Number: (212)751-4864

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using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Email: angela.amaru@lw.com

Correspondent Name: LATHAM & WATKINS LLP C/O ANGELA M. AMARU

Address Line 1: 1271 AVENUE OF THE AMERICAS Address Line 4: NEW YORK, NEW YORK 10020

ATTORNEY DOCKET NUMBER:	030786-0725
NAME OF SUBMITTER:	ANGELA M. AMARU
SIGNATURE:	/s/Angela M. Amaru
DATE SIGNED:	11/17/2022

Total Attachments: 37

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ASSIGNMENT OF SECURITY INTEREST IN PATENT COLLATERAL

This ASSIGNMENT OF SECURITY INTEREST IN PATENT COLLATERAL (this "Assignment"), dated as of November 15, 2022, is entered into by and between BARCLAYS BANK PLC ("Assignor") and CITIBANK, N.A. ("Assignee"). All capitalized terms used herein and not otherwise defined shall have the respective meanings given to such terms in the Patent Security Agreement referred to below, whether directly therein, or by reference to another agreement.

WHEREAS, pursuant to that certain Pledge and Security Agreement, dated as of January 31, 2019 (as amended, restated, amended and restated, supplemented or otherwise modified from time to time, the "Pledge and Security Agreement") among Assignor and Alent, Inc., Alpha Assembly Solutions Inc., MacDermid Acumen, Inc., MacDermid Enthone America LLC, MacDermid Enthone Inc., MacDermid Graphics Solutions, LLC, MacDermid Offshore Solutions, LLC, MacDermid, Incorporated and Napp Systems Inc. (each a "Grantor" and collectively the "Grantors") and certain other parties, the Grantors executed and delivered that certain Patent Security Agreement, dated as of January 31, 2019 (the "Patent Security Agreement"), pursuant to which each Grantor granted to Assignor, for the ratable benefit of the Secured Parties, a security interest in, all of all of the Patent Collateral of such Grantor, including the patents and patent applications of such Grantor listed on Schedule I hereto;

WHEREAS, Assignor recorded the Patent Security Agreement with the United States Patent and Trademark Office on February 5, 2019 at Reel/Frame 048260/0613 (with respect to the Patent Collateral of Alent, Inc.), at Reel/Frame 048260/0683 (with respect to the Patent Collateral of Alpha Assembly Solutions, Inc.), at Reel/Frame 048260/0828 (with respect to the Patent Collateral of MacDermid Acumen, Inc.), at Reel/Frame 048261/0110 (with respect to the Patent Collateral of MacDermid Enthone Inc.), at Reel/Frame 049855/0001 (with respect to the Patent Collateral of MacDermid Graphics Solutions, LLC), at Reel/Frame 048262/0321 (with respect to the Patent Collateral of MacDermid, Incorporated), and at Reel/Frame 048261/0356 (with respect to the Patent Collateral of Napp Systems, Inc.);

WHEREAS, Assignor has resigned as collateral agent, and Assignee has been appointed as the successor collateral agent, and accordingly Assignor has assigned to Assignee, and Assignee has assumed, all of Assignor's rights and obligations under the Pledge and Security Agreement and the Patent Security Agreement and the security interests granted thereunder; and

WHEREAS, Assignor and Assignee desire to confirm the foregoing assignment and assumption in this Assignment for purposes of recording it with the United States Patent and Trademark Office.

NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, Assignor hereby assigns to Assignee, and Assignee hereby assumes, all of Assignor's right, title and interest in, to and under, the Patent Collateral and the Patent Security Agreement, including, without limitation, its security interest in the Patent Collateral. The foregoing Assignment is made without recourse, representations or warranties of any kind.

[Signature Pages Follow]

IN WITNESS WHEREOF, Assignor has duly executed this ASSIGNMENT OF SECURITY INTEREST IN PATENT COLLATERAL as of the date first above written.

BARCLAYS BANK PLC.

as Assignor

y:_____

Name: Edward Brooks Title: Vice President

ACCEPTANCE AND ASSUMPTION

Assignee, as successor collateral agent, accepts and assumes the foregoing Assignment.

DATED as of the 15 day of November, 2022.

CITIBANK, N.A., as Assignee

Name: David Jaffe

Title: Vice President

[Signature Page to Assignement of Security Interest in Patent Collateral]

SCHEDULE I PATENTS AND PATENT APPLICATIONS

4

US-DOCS\136778294.2

SCHEDULE I TO PATENT SECURITY AGREEMENT

PATENTS AND PATENT APPLICATIONS:

				:	Methods	-
Published			9/27/2017	15/716963	Solder Preforms and Solder Alloy Assembly	Alpha Assembly Solutions Inc.
					Electrical Devices and Related Methods	
Granted	11/6/2018	10123430	10/17/2007	11/873838	Materials for Use with Interconnectors of	Alpha Assembly Solutions Inc.
					Conductive Pattern on a Substrate	
Granted	4/4/2017	9615463	9/19/2007	11/857871	Method for Producing a High Aspect Ratio	Alpha Assembly Solutions Inc.
					Them	
Published			2/22/2017	15/439555	Conductive Patterns and Methods of Using	Alpha Assembly Solutions Inc.
Granted	12/22/2015	9217088	6/24/2011	13/168465	Particles and Inks and Films Using Them	Alpha Assembly Solutions Inc. ¹
Pending			5/2/2017		High Reliability Lead-Free Solder Alloy	Alpha Assembly Solutions Inc.
Published			12/14/2016	15/318829	Engineered Residue Solder Paste Technology	Alpha Assembly Solutions Inc.
					Solder Hierarchy	
Published			1/13/2017	15/326180	Low Temperature High Reliability Alloy for	Alpha Assembly Solutions Inc.
					Surfaces	
Published			1/16/2017	15/326224	Stretchable Interconnects for Flexible Electronic	Alpha Assembly Solutions Inc.
Granted	11/20/2018	10130995	10/7/2016	15/302712	Method for Manufacturing Metal Powder	Alpha Assembly Solutions Inc.
					Interconnects	
Published			10/6/2016	15/286759	Advanced Solder Alloys for Electronic	Alpha Assembly Solutions Inc.
Published			9/14/2016	15/265385	Production of Graphene	Alpha Assembly Solutions Inc.
					SAME	
					ADHESIVE CURING SYSTEM USING THE	
Granted	8/30/2005	6,936,644	10/16/2002	10/271,511	RELEASABLE MICROCAPSULE AND	Alent, Inc.
				TAD:		
Status	Issue Date	Patent No.	Filing Date	Application	Title	Owner

¹ Appropriate documentation to be filed with the USPTO to update owner name from Alpha Metals, Inc.

Alpha Assembly Solutions Inc. ³ Flip	Alpha Assembly Solutions Inc. ² Solde Print	Alpha Assembly Solutions Inc. Engi	Alpha Assembly Solutions Inc. Sinte	Alpha Assembly Solutions Inc. Appl	Alpha Assembly Solutions Inc. JOIN	Alpha Assembly Solutions Inc. MET	Alpha Assembly Solutions Inc. HIGH IT ALLOY	Alpha Assembly Solutions Inc. HIGH	Alpha Assembly Solutions Inc. Conduction Them	Alpha Assembly Solutions Inc. Cond Them	Alpha Assembly Solutions Inc. Condu Them	Alpha Assembly Solutions Inc. RF S	Alpha Assembly Solutions Inc. Sinte Usin;	Alpha Assembly Solutions Inc. Elect	Alpha Assembly Solutions Inc. Lead	Alpha Assembly Solutions Inc. Com Joini	ļ.	Alpha Assembly Solutions Inc. Dual	Alpha Assembly Solutions Inc. Flux	Alpha Assembly Solutions Inc. Solder P Methods	Owner
Flip chip with integrated flux and underfill	Soldering Flux Vehicle Additive and Fine Pitch Printing Method	Engineered Flux for Solder Paste	Sintered Nano Copper Paste and Film	Applications of Engineered Graphenes	JOINING TO ALUMINIUM	METAL RECOVERY	HIGH IMPACT SOLDER TOUGHNESS	HIGH IMPACT TOUGHNESS ALLOY	Conductive Compositions and Methods of Using Them	Conductive Compositions and Methods of Using Them	Conductive Compositions and Methods of Using Them	RF SHIELD WITH SELECTIVELY INTEGRATED SOLDER	Sintering Materials and Attachment Methods Using Same	Electrical Connection Tape	Lead-Free, Silver-Free Solder Alloys	Joining Electrical and Mechanical Components	Rosin-Free Thermosetting Flux Formulations	Dual Side Reinforcement Flux for Encapsulation	Flux Formulations	Solder Preforms and Solder Alloy Assembly Methods	Title
09067381	10036952		62/689962	62/655409	14/909888	14/900493	16/003202	15/644331	14/058553	12/567523	15/148320	15/426320	15/316684	15/549535	15/028988	14/913007	15/109352	14/908986	15/390861	14/386601	Application No.
4/27/1998	12/21/2001		6/26/2018	4/10/2018	2/3/2016	12/21/2015	6/8/2018	7/7/2017	10/21/2013	9/25/2009	5/6/2016	2/7/2017	12/6/2016	8/8/2017	4/13/2016	2/20/2010	212612016	1/29/2016	12/27/2016	3/15/2013	Filing Date
6265776	6936115				10065274				9355938	8564140	10059827						6/30/2016	9786629	9751159	9801285	Patent No.
7/24/2001	8/30/2005				9/4/2018				5/31/2016	10/22/2013	8/28/2018						10/31/2017	10/10/2017	9/5/2017	10/24/2017	Issue Date
Granted	Granted	Unfiled	Pending	Pending	Granted	Published	Published	Published	Granted	Granted	Granted	Published	Published	Published	Published	ruonsned	Granted PA	Granted	Granted	Granted	Status

² Appropriate documentation to be filed with the USPTO to update owner name from Alpha Metals, Inc.

³ Appropriate documentation to be filed with the USPTO to update owner name from Alpha Metals, Inc.

Granted	2/27/2001 11/20/2001 9/25/2001 9/25/2001 11/27/2001 5/8/2001 5/8/2003 2/25/2003 11/25/2003 8/29/2006	6194788 6319543 6294220 6323062 6228681 6599372 6524398 6653741 7097806	3/10/1999 3/31/1999 6/30/1999 9/14/1999 9/14/1999 12/1/2000 4/12/2001 5/20/2002 8/15/2003	0926232 0926232 09282729 09345675 09395553 09395558 09728264 09728264 09834196 10151741 10363420	Flip chip with integrated flux and underfill Process for silver plating in printed circuit board manufacture Post-treatment for copper on printed circuit boards Wafer coating method for flip chips Flip chip having integral mask and underfill providing two-stage bump formation Soldering Flux Low-residue, low-solder-ball flux Thermal interface material and heat sink configuration Rapid surface cooling of solder droplets by flash evaporation	Alpha Assembly Solutions Inc. 6 Alpha Assembly Solutions Inc. 7 Alpha Assembly Solutions Inc. 8 Alpha Assembly Solutions Inc. 9 Alpha Assembly Solutions Inc. 10 Alpha Assembly Solutions Inc. 11 Alpha Assembly Solutions Inc. 11 Alpha Assembly Solutions Inc. 12 Alpha Assembly Solutions Inc. 12 Alpha Assembly Solutions Inc. 13
Granted	9/26/2000	6123024 6228678	1/14/1999 3/10/1999	09231490	Stencil incorporating electronic tag Flin chin with integrated mask and underfill	Alpha Assembly Solutions Inc. ⁴
Status	Issue Date	Patent No.	Filing Date	Application No.	Title	Owner

⁶ Appropriate documentation to be filed with the USPTO to update owner name from Alpha Metals, Inc

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Owner	Title	Application No.	Filing Date	Patent No.	Issue Date	Status
Alpha Assembly Solutions Inc. 15	Thermoplastic fluxing underfill composition and method	10458925	6/11/2003	7166491	1/23/2007	Granted
Alpha Assembly Solutions Inc. 16	Thermal interface material and solder preforms	10722288	11/25/2003	7187083	3/6/2007	Granted
Alpha Assembly Solutions Inc. 17	UNDERFILL FLUXING CURATIVE	10817138	4/2/2004	7213739	5/8/2007	Granted
Alpha Assembly Solutions Inc. 18	METHOD OF APPLYING A PATTERN OF	10888286	7/9/2004	7585549	9/8/2009	Granted
	PARTICLES TO A SUBSTRATE					
Alpha Assembly Solutions Inc. 19	COATING SOLDER METAL PARTICLES	10888619	7/9/2004	7413771	8/19/2008	Granted
	WITH A CHARGE DIRECTOR MEDIUM					
Alpha Assembly Solutions Inc. 20	COATED STENCIL WITH REDUCED	10899679	7/26/2004	7093746	8/22/2006	Granted
	SURFACE TENSION					
Alpha Assembly Solutions Inc. ²¹	LOW VOIDING NO FLOW FLUXING UNDERFILL FOR ELECTRONIC DEVICES	10911908	8/5/2004	7247683	7/24/2007	Granted
Alpha Assembly Solutions Inc. 22	SOLDER PREFORMS FOR USE IN	11012457	12/15/2004	7533793	5/19/2009	Granted
	ELECTRONIC ASSEMBLY					
Alpha Assembly Solutions Inc. 23	Multilayered Metal Nano and Micron Particles	15318895	12/14/2016			Pending
Alpha Assembly Solutions Inc. 24	Jettable Inks For Solar Cell and Semiconductor	15312799	11/21/2016			Pending
	Fabrication					

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					using the methods	
Pending			9/16/2013	14027530	Methods for attachment and devices produced	Alpha Assembly Solutions Inc. 34
Pending			12/3/2013	14095559	Solvent systems for metals and inks	Alpha Assembly Solutions Inc. 33
Pending			3/21/2014	14236432	High impact toughness solder alloy	Alpha Assembly Solutions Inc. 32
Pending			3/21/2014	14236480	Solder compositions	Alpha Assembly Solutions Inc. 31
					solder joint	
Pending			3/25/2014	14347035	Systems and methods for void reduction in a	Alpha Assembly Solutions Inc. 30
					at high temperatures	
Pending			4/9/2015	14434470	Lead-free and antimony-free tin solder reliable	Alpha Assembly Solutions Inc. 29
Pending			4/28/2015	14438888	Sintering powder	Alpha Assembly Solutions Inc. 28
					at high temperatures	
Pending			4/28/2015	14698450	Lead-free and antimony-free tin solder reliable	Alpha Assembly Solutions Inc. ²⁷
					at high temperatures	
Pending			10/8/2015	14878056	Lead-free and antimony-free tin solder reliable	Alpha Assembly Solutions Inc. ²⁶
Pending			10/7/2016	15302827	Low Pressure Sintering Powder	Alpha Assembly Solutions Inc. 25
			Ş	No.		
Status	Issue Date	Patent No.	Filing Date	Application	Title	Owner

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Owner	Title	Application No.	Filing Date	Patent No.	Issue Date	Status
Alpha Assembly Solutions Inc. 35	Sintering materials and attachment methods	13287820	11/2/2011			Pending
	using same					
Alpha Assembly Solutions Inc. ³⁶	Flux formulations	12497065	7/2/2009			Pending
Alpha Assembly Solutions Inc. 37	Process for silver plating in printed circuit board	13471203	5/14/2012	RE45279	12/9/2014	Granted
	manufacture					
Alpha Assembly Solutions Inc. 38	Process for silver plating in printed circuit board	13655159	10/18/2012	RE45175	10/7/2014	Granted
	manufacture					
Alpha Assembly Solutions Inc. 39	Flux formulations	14077995	11/12/2013	9566668	2/14/2017	Granted
Alpha Assembly Solutions Inc. 40	Electrical contacts	12052104	3/20/2008	9362424	6/7/2016	Granted
Alpha Assembly Solutions Inc. 41	Solder alloy	11720578	7/25/2008	9221131	12/29/2015	Granted
Alpha Assembly Solutions Inc. 42	Solder alloy	12036497	2/25/2008	8641964	2/4/2014	Granted
Alpha Assembly Solutions Inc. 43	Solvent systems for metals and inks	11857818	9/19/2007	8597548	12/3/2013	Granted
Alpha Assembly Solutions Inc. 44	Methods of attaching a die to a substrate	12175375	7/17/2008	8555491	10/15/2013	Granted
Alpha Assembly Solutions Inc. 45	Methods for producing electrical conductors	12052166	3/20/2008	8312623	11/20/2012	Granted

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Granted Granted Granted Pending	2/2/2010 8/19/2008 11/6/2018	7655304 7413805 10123430	8/14/2008 2/25/2005 10/17/2007 10/6/2016	12191710 11065764 11873838 11873838	Coated solder metal particles Preparation of metallic particles for electrokinetic or electrostatic deposition Materials for use with interconnects of electrical devices and related methods Advanced Solder Alloys For Electronic Interconnects	Alpha Assembly Solutions Inc. 53 Alpha Assembly Solutions Inc. 54 Alpha Assembly Solutions Inc. Alpha Assembly Solutions Inc.
Granted Granted	7/6/2010 3/16/2010 2/16/2010	7749883 7678255 7663242	8/29/2008 5/18/2006 3/6/2007	12201654 11419128 11682729	Electroformed stencils for solar cell front side metallization Mask and method for electrokinetic deposition and patterning process on substrates Thermal interface material and solder preforms	Alpha Assembly Solutions Inc. 50 Alpha Assembly Solutions Inc. 51 Alpha Assembly Solutions Inc. 52
Granted Granted Granted	8/28/2012 6/5/2012 6/28/2011	8252417 8191757 7968008	8/14/2008 2/25/2008 8/3/2006	12191691 12036604 11462089	Metallic particles for electrokinetic or electrostatic deposition Reducing joint embrittlement in lead-free soldering processes Particles and inks and films using them	Alpha Assembly Solutions Inc. 47 Alpha Assembly Solutions Inc. 48 Alpha Assembly Solutions Inc. 49
Status Granted	Issue Date 11/6/2012	Patent No. 8304062	Filing Date 7/17/2008	Application No.	Title Electrical conductors and methods of making and using them	Owner Alpha Assembly Solutions Inc. 46

⁴⁷ Appropriate documentation to be filed with the USPTO to update owner name from Alpha Metals, Inc. ⁴⁶ Appropriate documentation to be filed with the USPTO to update owner name from Alpha Metals, Inc.

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	Granted	5/13/2003	6562221	9/28/2001	09/965743	Process & Composition for High Speed Plating of Tin & Tin Alloys	MacDermid Acumen, Inc.
<u> </u>	Granted	4/30/2002	6379750	11/22/2000	09/718910	Process for Enhancing the Adhesion of Organic Coatings to Metal Surfaces	MacDermid Acumen, Inc.
	Granted	7/17/2001	6261381	11/9/2000	09/710976	Composition and Process for Cleaning Inks from Various Substrates Including Printing Plates	MacDermid Acumen, Inc.
<u> </u>	Granted	7/9/2002	6417149	9/7/2001	09/949191	Paint Stripping Composition and Process Containing Methyl Benzoate and Formic Acid	MacDermid Acumen, Inc.
l	Granted	12/2/2003	6656370	10/13/2000	09/687880	Method for the Manufacture of Printed Circuit Boards	MacDermid Acumen, Inc.
<u> </u>	Granted	11/5/2002	6474536	9/28/2000	09/672577	Flux Composition and Corresponding Soldering Method	MacDermid Acumen, Inc.
	Granted	4/23/2002	6375822	10/3/2000	09/677904	Method for Enhancing the Solderability of a Surface	MacDermid Acumen, Inc.
<u> </u>	Granted	4/29/2003	6554948	8/22/2000	09/643813	Process for Improving the Adhesion of Polymeric Materials to Metal Surfaces	MacDermid Acumen, Inc.
L	Granted	1/7/2003	6503566	2/27/2002	10/090048	Process for Improving the Adhesion of Polymeric Materials to Metal Surfaces	MacDermid Acumen, Inc.
	Granted	5/7/2002	6383272	6/8/2000	09/590046	Process for Improving the Adhesion of Polymeric Materials to Metal Surfaces	MacDermid Acumen, Inc.
	Granted	3/27/2001	6206981	10/21/1999	09/421204	Process for Enhancing the Adhesion of Organic Coatings to Metal Surfaces	MacDermid Acumen, Inc.
' F	Granted	12/19/2000	6162503	3/23/1999	09/274641	Process for Improving the Adhesion of Polymeric Materials to Metal Surfaces	MacDermid Acumen, Inc.
Ά	Pending			12/27/2018	62785293	Lead-Free Solder Compositions	Alpha Assembly Solutions Inc. 57
TE	Pending			1/30/2017	15419564	High Impact Solder Toughness Alloy	Alpha Assembly Solutions Inc. ⁵⁶
ENT	Pending			2/8/2016	15017975	Sintering Materials and Attachment Methods Using Same	Alpha Assembly Solutions Inc. 55
	Pending			9/27/2017	15562195	Engineered Polymer-Based Electronic Materials	Alpha Assembly Solutions Inc.
	Status	Issue Date	Patent No.	Filing Date	Application No.	Title	Owner

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Owner	Title	Application No.	Filing Date	Patent No.	Issue Date	Status
MacDermid Acumen, Inc.	Method for the Manufacture of Printed Circuit Boards with Plated Resistors	09/784242	2/15/2001	6585904	7/1/2003	Granted
MacDermid Acumen, Inc.	Method for the Manufacture of Printed Circuit Boards with Plated Resistors	10/419651	4/21/2003	7034231	4/25/2006	Granted TEN
MacDermid Acumen, Inc.	High Temperature Continuous Eloectrodialysis of Electroless Plating Solutions	09/788766	2/20/2001	6391177	5/21/2002	Granted
MacDermid Acumen, Inc.	Composition & Method for Inhibiting Corrosion of Aluminum & Aluminum Alloys Using Mercapto Substituted Silanes	09/802087	3/8/2001	6461682	10/8/2002	Granted
MacDermid Acumen, Inc. 58	Electroplating Composition and Process	09/803631	3/9/2001	6582582	6/24/2003	Granted
MacDermid Acumen, Inc. 59	Composition and Process for Inhibiting Corrosion of Metallic Substrates	09/906370	7/16/2001	6508958	1/21/2003	Granted
MacDermid Acumen, Inc.	Composition and Process for Inhibiting Corrosion of Metallic Substrates	10/328197	12/23/2002	6706214	3/16/2004	Granted
MacDermid Acumen, Inc.	Electroless Nickel Plating Solution & Process for its Use	09/945011	8/31/2001	6500482	12/31/2002	Granted
MacDermid Acumen, Inc.	Non-Chrome Passivation Process for Zinc & Zinc Alloys	09/938234	8/23/2001	6524403	2/25/2003	Granted
MacDermid Acumen, Inc.	Process for Plating Particulate Matter	09/946404	9/5/2001	6586047	7/1/2003	Granted
MacDermid Acumen, Inc.	Noncyanide Copper Plating Process for Zinc & Zinc Alloys	10/096411	3/12/2002	6827834	12/7/2004	Granted
MacDermid Acumen, Inc.	Magnesium Conversion Coating Composition and Method of Using Same	10/076897	2/14/2002	6692583	2/17/2004	Granted
MacDermid Acumen, Inc.	Method of Stripping Silver from a Printed Circuit Board	10/106522	3/25/2002	6783690	8/31/2004	Granted
MacDermid Acumen, Inc.	Method for the Manufacture of Printed Circuit Boards with Integral Plated Resistors	10/271817	10/16/2002	6767445	7/27/2004	Granted
MacDermid Acumen, Inc.	Method of Fabricating Electronic Interconnect Devices Using Direct Imaging of Dielectric Composite Material	10/372747	2/24/2003	6762073	7/13/2004	Granted
MacDermid Acumen, Inc.	Coating for Silver Plated Circuits	10/412932	4/14/2003	6773757	8/10/2004	Granted

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	Granted	9/11/2012	8263177	3/27/2009	12/383650	Organic Polymer Coatings for Protection Against Creep Corrosion	MacDermid Acumen, Inc.
	Granted	8/24/2010	7780840	10/30/2008	12/261352	Process for Plating Chromium from a Trivalent Chromium Plating Bath	MacDermid Acumen, Inc.
	Granted	12/15/2009	7631798	10/2/2008	12/244136	Method for Enhancing the Solderability of a Surface	MacDermid Acumen, Inc.
<u> </u>	Granted	8/27/2013	8518281	6/3/2008	12/156613	Acid-Resistance Promoting Composition	MacDermid Acumen, Inc.
	Granted	1/3/2012	8088246	1/8/2009	12/350380	Process for Improving the Adhesion of Polymeric Materials to Metal Surfaces	MacDermid Acumen, Inc.
	Granted	2/15/2011	7887693	6/22/2007	11/821206	Acid Copper Electroplating Bath Composition	MacDermid Acumen, Inc.
	Granted	11/16/2010	7833583	3/27/2007	11/728757	Method of Recycling Electroless Nickel Waste	MacDermid Acumen, Inc.
<u> </u>	Granted	1/12/2010	7645393	4/27/2007	11/796660	Metal Surface Treatment Composition	MacDermid Acumen, Inc.
	Granted	4/27/2010	7704562	8/14/2006	11/503780	Process for Improving the Adhesion of Polymeric Materials to Metal Surfaces	MacDermid Acumen, Inc.
	Granted	8/18/2009	7575666	4/5/2006	11/398048	Process for Electrolytically Plating Copper	MacDermid Acumen, Inc.
	Granted	12/26/2006	7153408	4/13/2006	11/403628	Copper Electroplating of Printing Cylinders	MacDermid Acumen, Inc.
<u> </u>	Granted	1/25/2011	7875558	8/14/2007	11/893068	Microetching Composition and Method of Using the Same	MacDermid Acumen, Inc.
	Granted	11/25/2008	7456114	12/21/2005	11/316010	Microetching Composition and Method of Using the Same	MacDermid Acumen, Inc.
	Granted	8/22/2006	7094523	11/30/2005	11/290118	Developer Solution and Process for Use	MacDermid Acumen, Inc.
	Granted	7/1/2008	7393461	8/23/2005	11/209471	Microetching Solution	MacDermid Acumen, Inc.
<u> </u>	Granted	4/27/2010	7704366	8/17/2005	11/205516	Pretreatment of Magnesium Substrates for Electroplating	MacDermid Acumen, Inc.
L _	Granted	8/14/2007	7255782	4/30/2004	10/837109	Selective Catalytic Activation of Non- Conductive Substrates	MacDermid Acumen, Inc.
I 	Granted	10/31/2006	7128820	3/11/2004	10/798522	Process for Preparing a Non-Conductive Substrate for Electroplating	MacDermid Acumen, Inc.
1	Granted	6/20/2006	7063800	11/10/2003	10/705026	Methods of Cleaning Copper Surfaces in the Manufacture of Printed Circuit Boards	MacDermid Acumen, Inc.
	Granted	12/6/2005	6972143	10/27/2003	10/694375	Protective U.V. Curable Cover Layer for Optical Media	MacDermid Acumen, Inc.
TEN	Granted	5/27/2008	7378225	4/6/2004	10/820236	Method of Forming a Metal Pattern on a Substrate	MacDermid Acumen, Inc.
	Granted	1/4/2005	6837923	5/7/2003	10/431251	Polytetrafluoroethylene Dispersion for Electroless Nickel Plating Applications	MacDermid Acumen, Inc.
	Status	Issue Date	Patent No.	Filing Date	Application No.	Title	Owner

Granted	9/3/2013	8524540	2/1/2011	13/018668	Adhesion Promoting Composition for Metal	MacDermid Acumen, Inc.
Granted	5/12/2015	9030008	7/30/2013	13/954328	Adhesion Promoting Composition for Metal Leadframes	MacDermid Acumen, Inc.
Granted	7/30/2013	8496762	2/4/2011	13/021026	Aluminium Treatment Compositions	MacDermid Acumen, Inc.
Granted	8/20/2013	8512541	11/16/2010	12/947059	Electrolytic Dissolution of Chromium from Chromium Electrodes	MacDermid Acumen, Inc.
Granted	9/25/2012	8273235	11/5/2010	12/940249	Dark Colored Chromium Based Electrodeposits	MacDermid Acumen, Inc.
Granted	5/24/2016	9347144	8/24/2012	13/593690	Dark Colored Chromium Based Electrodeposits	MacDermid Acumen, Inc.
Granted	4/8/2014	8691987	9/24/2010	12/890013	Method of Producing Polymeric Phenazonium Compounds	MacDermid Acumen, Inc.
Granted	5/27/2014	8735580	9/21/2011	13/238832	Improved Method of Producing Polymeric Phenazonium Compounds	MacDermid Acumen, Inc.
Granted	5/26/2015	9040700	2/17/2014	14/181866	Improved Method of Producing Polymeric Phenazonium Compounds	MacDermid Acumen, Inc.
Granted	3/10/2015	8974869	1/26/2010	12/693548	Method for Improving Plating on Non- Conductive Substrates	MacDermid Acumen, Inc.
Granted	6/30/2015	9067238	1/15/2013	13/741446	Method for Improving Plating on Non- Conductive Substrates	MacDermid Acumen, Inc.
Granted	11/13/2012	8308893	2/1/2010	12/697425	Nano-Oxide Process for Bonding Copper/Copper Alloy and Resin	MacDermid Acumen, Inc.
Granted	12/25/2012	8337942	7/22/2011	13/188615	Light Induced Electroless Plating	MacDermid Acumen, Inc.
Granted	5/13/2014	8722142	8/28/2009	12/549547	Light Induced Electroless Plating	MacDermid Acumen, Inc.
Granted	2/17/2015	8956687	11/20/2012	13/681722	Light Induced Plating of Metals on Silicon Photovoltaic Cells	MacDermid Acumen, Inc.
Granted	7/16/2013	8486281	10/5/2009	12/573298	Nickel-Chromium Alloy Stripper for Flexible Wiring Boards	MacDermid Acumen, Inc.
Granted	8/2/2011	7989346	7/27/2009	12/509619	Surface Treatment of Silicon	MacDermid Acumen, Inc.
Granted	3/10/2015	89/4860	6/19/2009	12/488158	Selective Deposition of Metal on Plastic Substrates	MacDermid Acumen, Inc.
Published			8/16/201/	15/6/8//1	Chromium Alloy Coating with Ennanced Resistance to Corrosion in Calcium Chloride Environments	MacDermid Acumen, inc.
Granted	9/19/2017	9765437	3/24/2009	12/409629	Chromium Alloy Coating with Enhanced Resistance to Corrosion in Calcium Chloride Environments	MacDermid Acumen, Inc.
Status	Issue Date	Patent No.	Filing Date	Application No.	Title	Owner

MacDermid Acumen, Inc.	MacDermid Acumen, Inc.	MacDermid Acumen, Inc. Tr	MacDermid Acumen, Inc. Hi	MacDermid Acumen, Inc. Programme Pro	MacDermid Acumen, Inc. El	MacDermid Acumen, Inc. EI	MacDermid Acumen, Inc. Zi	MacDermid Acumen, Inc. A	MacDermid Acumen, Inc. El	MacDermid Acumen, Inc. Re	MacDermid Acumen, Inc. A	MacDermid Acumen, Inc. Et	MacDermid Acumen, Inc. El	MacDermid Acumen, Inc. Et	MacDermid Acumen, Inc. EI	MacDermid Acumen, Inc. Et	MacDermid Acumen, Inc. Et	MacDermid Acumen, Inc. Co	
Dark Coloured Chromium Based Electrodeposits	Treatment of Etch Baths	Treatment for Electroplating Racks to Avoid Rack Metallization	High Phosphorus Electroless Nickel	Passivation of Micro-Discontinuous Chromium Deposited from a Trivalent Electrolyte	Electroplating of Metals on Transparent Conductive Oxide Substrates	Electrolyte Media for the Deposition of Tin Alloys and Methods for Depositing Tin Alloys	Zinc and Zinc Alloy Electroplating Additives and Electroplating Methods	Aqueous Electroless Nickel Plating Bath and Method of Using the Same	Electroless Nickel Plating Solution and Method	Regeneration of Etch Solutions Containing Trivalent Manganese in Acid Media	Additives for Producing Copper Electrodeposits Having Low Oxygen Content	Etching of Plastic Using Acidic Solutions Containing Trivalent Manganese	Electrolytic Generation of Manganese (III) Ions in Strong Sulfuric Acid	Etching of Plastic Using Acidic Solutions Containing Trivalent Manganese	Electrolytic Generation of Manganese (III) Ions in Strong Sulfuric Acid Using an Improved Anode	Etching of Plastic Using Acidic Solutions Containing Trivalent Manganese	Etching of Plastic Using Acidic Solutions Containing Trivalent Manganese	Color Control of Trivalent Chromium Deposits	
15/134469	14/870738	14/454131	14/294437	14/200546	14/204241	10/470792	10/333484	14/293216	13/961018	13/870232	13/480887	15/934127	13/795382	13/356004	13/677798	15/357385	14/467105	13/398111	NO.
4/21/2016	9/30/2015	8/7/2014	6/3/2014	3///2014	3/11/2014	7/30/2003	5/29/2003	6/2/2014	8/7/2013	4/25/2013	5/25/2012	3/23/2018	3/12/2013	1/23/2012	11/15/2012	11/21/2016	8/25/2014	2/16/2012	
		9809899	9708693		9783901	7309411	7109375				9243339		9534306		9752241			9758884	
		11/7/2017	7/18/2017		10/10/2017	12/18/2007	9/19/2006				1/26/2016		1/3/2017		9/5/2017			9/12/2017	
Published	Published	Granted	Granted	Appealed	Granted	Granted	Granted	Published	Published	Appealed	Granted	Published	Granted	Published	Granted	Published PATI	Published	Granted	

	Granted	3/6/2007	7186305	11/26/2002	10304514	Process for improving the adhesion of polymeric materials to metal surfaces	MacDermid Acumen, Inc.
	Granted	4/4/2006	7022464	8/25/2004	10925589	Integral plated resistor and method for the manufacture of printed circuit boards comprising the same	MacDermid Acumen, Inc.
	Granted	10/14/2003	6632588	7/8/2002	10190873	Direct imaging process for forming resist pattern on a surface, and use thereof in fabricating printing plates	MacDermid Acumen, Inc.
	Granted	7/16/2002	6419784	6/21/2000	09598857	Process for improving the adhesion of polymeric materials to metal surfaces	MacDermid Acumen, Inc.
	Granted	6/25/2002	6409850	11/3/1999	09147972	Fluxing agents for the reflowing of electrodeposited tinplate	MacDermid Acumen, Inc.
	Granted	8/28/2001	6281090	6/27/2000	09603978	Method for the manufacture of printed circuit boards with plated resistors	MacDermid Acumen, Inc.
	Granted	4/17/2001	6217738	12/17/1998	09051784	Tin plating electrolyte compositions	MacDermid Acumen, Inc.
	Granted	4/10/2001	6214522	8/28/1998	09143427	Photosensitive resin composition useful in fabricating printing plates	MacDermid Acumen, Inc.
	Granted	3/6/2001	6197459	7/21/2000	09620884	Photosensitive resin composition useful in fabricating printing plates	MacDermid Acumen, Inc.
	Granted	1/2/2001	6168836	10/30/1998	09183137	PROCESS FOR PLATING UPON A POLYMERIC SURFACE	MacDermid Acumen, Inc.
	Pending			1/19/2012	13353428	Low Etch Process for Direct Metallization	MacDermid Acumen, Inc.
	Pending			2/16/2012	13398242	Coatings Having Enhanced Corrosion Performance and Method of Using the Same	MacDermid Acumen, Inc.
l	Pending			4/3/2012	13438149	Additive for Use in Wash Step of PET Recycling Process	MacDermid Acumen, Inc.
1	Pending			8/7/2012	13568277	Steel Pre-Paint Treatment Composition	MacDermid Acumen, Inc.
I	Pending			9/11/2012	13609705	Direct Electroless Palladium Plating on Copper	MacDermid Acumen, Inc.
l	Pending			3/6/2013	13786728	High Speed Copper Plating Process	MacDermid Acumen, Inc.
PA	Pending			8/20/2015	14831266	Solutions of Organic Salts as Pretreatments for Plastic Prior to Etching	MacDermid Acumen, Inc.
 TEN	Pending			8/20/2015	14831403	Electroless Silver Plating Bath and Method of Using the Same	MacDermid Acumen, Inc.
 T	Published	11/27/2018	10138566	1/13/2017	15/405417	Sealing Anodized Aluminum Using a Low- Temperature Nickel-Free Process	MacDermid Acumen, Inc.
	Status	Issue Date	Patent No.	Filing Date	Application No.	Title	Owner

	Pending			6/8/2017	15/617482	Process for Metallization of Copper Pillars in the Manufacture of Microelectronics	MacDermid Enthone Inc.
	Pending			7/5/2017	15/641756	Cobalt Filling of Interconnects	MacDermid Enthone Inc.
	Published			6///201/	15/616540	Use of water soluble lanthanide compounds as stabilizer in electrolytes for electroless metal deposition	MacDermid Enthone Inc.
	Pending			10/6/2016	15//6565/	Ose of water Soluble and Air Stable Phosphaadamantanes as stabilizer in Electrolytes for Electroless Metal Deposition	MacDermid Enthone Inc.
	Published			8/15/2016	15/754224	System and Process for Recovering Catalytic Precious Metal from Aqueous Galvanic Processing Solution	MacDermid Enthone Inc.
	Published			9/23/2016	15/762599	Flexible Color Adjustment for Dark CR (III) Platings	MacDermid Enthone Inc.
	Pending			8/15/2017	15551052	Inhibitor Composition for Racks When Using Chrome Free Etches in a Plating on Plastics Process	MacDermid Enthone Inc
	Granted	7/16/2002	6419340	3/2/1999	09260925	Method for automatically forming ink and media-dependent color transforms for diverse colored inks and ink types, validating color gamut, and applying said inks	MacDermid Acumen, Inc. and Hewlett-Packard Development Company, L.P.
							MacDermid Acumen, Inc.
	Granted	8/20/2013	8512504	5/6/2009	12436260	Process for Improving Adhesion of Polymeric Materials to Metal Surfaces	MacDermid Acumen, Inc.
L	Granted	5/15/2012	8177956	3/12/2008	12046864	Method of electrolytically dissolving nickel into electroless nickel plating solutions	MacDermid Acumen, Inc.
	Granted	2/23/2010	7666471	3/22/2006	11386631	Polyimide substrate and method of manufacturing printed wiring board using the same	MacDermid Acumen, Inc.
	Granted	9/30/2008	7429400	12/14/2005	11300254	Method of using ultrasonics to plate silver	MacDermid Acumen, Inc.
 • Ρ Δ	Granted	2/12/2008	7329334	9/16/2004	10943113	Controlling the hardness of electrodeposited copper coatings by variation of current profile	MacDermid Acumen, Inc.
 TEN	Granted	10/9/2007	7279108	2/6/2006	11348941	Method for the manufacture of printed circuit boards with plated resistors	MacDermid Acumen, Inc.
 !T	Granted	5/8/2007	7214304	10/13/2004	10964212	Process for preparing a non-conductive substrate for electroplating	MacDermid Acumen, Inc.
	Status	Issue Date	Patent No.	Filing Date	Application No.	Title	Owner

MacDermid Enthone Inc. MacDermid Enthone Inc.	Leveler Compositions for use in Copper Deposition in Manufacture of Microelectronics Cobalt Filling of Interconnects in Microelectronics SILVER PLATING IN ELECTRONICS MANUFACTURE [Silver] DEFECTIVITY AND PROCESS CONTROL OF ELECTROLESS DEPOSITION IN MICROELECTROLESS DEPOSITION OF BRONZES CHROMIUM-FREE PICKLE FOR PLASTIC SURFACES COMPOSITION OF CONDUCTIVE POLYMERS ON DIELECTRIC SUBSTRATES (ENVISION HDI) PROCESS FOR FILLING VIAS IN THE DEPOSITION OF REDUCED AIRBORNE PROCESS FOR FILLING VIAS IN THE MANUFACTURE OF MICROELECTRONICS (Anodic Pulse to Reduce Additive Build Up) [SC Cu] AQUEOUS ELECTROLYTE COMPOSITION HAVING A REDUCED AIRBORNE EMISSION, METHOD AND USE OF THIS COMPOSITION MICROELECTRONICS	Application No. 15/412809 15/42809 14/666990 11/243,631 11/243,624 11/766642 14/702020 13/882330 13/882330 14/916706 14/916706	1/23/2017 1/23/2017 6/30/2016 3/24/2015 10/5/2005 10/5/2005 10/5/2007 5/1/2015 2/5/2014 5/6/2016 3/4/2016 3/4/2016	Patent No. 9730321 7,611,988 7,611,987 7,611,987 10017863 9752074 10021782 10103029 101081876	8/8/2017 11/3/2009 11/3/2009 11/3/2018 7/10/2018 9/5/2017 10/16/2018	
	Leveler Compositions for use in Copper Deposition in Manufacture of Microelectronics Cobalt Filling of Interconnects in Microelectronics SILVER PLATING IN ELECTRONICS MANUFACTURE [Silver] DEFECTIVITY AND PROCESS CONTROL OF ELECTROLESS DEPOSITION IN MICROELECTRONICS APPLICATIONS [Cobalt] DEFECTIVITY AND PROCESS CONTROL OF ELECTROLESS DEPOSITION IN MICROELECTRONICS APPLICATIONS [Cobalt] CORROSION PROTECTION OF BRONZES CHROMIUM-FREE PICKLE FOR PLASTIC SURFACES COMPOSITION AND METHOD FOR THE DEPOSITION OF CONDUCTIVE	15/412809 15/739314 14/666990 11/243,631 11/243,624 11/766642 14/702020 13/882330	1/23/2017 6/30/2016 3/24/2015 10/5/2005 10/5/2005 6/21/2007 5/1/2015	9730321 7,611,988 7,611,987 7,611,987 10017863 9752074 10021782	8/8/2017 11/3/2009 11/3/2009 11/3/2009 7/10/2018 9/5/2017	
Ċ.	COMPOSITION AND METHOD FOR THE DEPOSITION OF CONDUCTIVE POLYMERS ON DIELECTRIC SUBSTRATES (ENVISION HDI)	13/882330	2/5/2014	10021782	7/10/20	18
Ic.	PROCESS FOR FILLING VIAS IN THE MANUFACTURE OF MICROELECTRONICS (Anodic Pulse to Reduce Additive Build Up) [SC Cu]	15/148738	5/6/2016	10103029	10/16/20	18
ıc.	AQUEOUS ELECTROLYTE COMPOSITION HAVING A REDUCED AIRBORNE EMISSION, METHOD AND USE OF THIS COMPOSITION	14/916706	3/4/2016	10081876	9/5/2018	
ic.	MICROELECTRONICS	14/854561	9/15/2015			
MacDermid Enthone Inc.	AQUEOUS STRIPPING COMPOSITION FOR METAL SURFACES	14/893854	11/24/2015	9834689	12/5/2017	7
MacDermid Enthone Inc.	COMPOSITIONS INCLUDING A HIGH MOLECULAR WEIGHT ACID SUITABLE FOR CONDUCTIVE POLYMER	15/545208	7/20/2017			

Owner	Title	Application No.	Filing Date	Patent No.	Issue Date	Status
	FORMATION ON DIELECTRIC SUBSTRATES					
MacDermid Enthone Inc.	Elimination of H2S in Immersion Tin Plating Solution	15/607925	5/30/2017			Pending
MacDermid Enthone Inc.	Textured Hardcoat Films	15/717275	9/27/2017			Pending
MacDermid Enthone Inc.	Carbon Based Direct Plating Process	15/973814	5/8/2018			
MacDermid Enthone Inc.	Electrolytic Deposition of Tin/Tin-X and Plating Method	16/059086	8/9/2018			Pending
MacDermid Enthone Inc.	NEAR NEUTRAL pH PICKLE ON MULTI- METALS	15/977526	5/11/2018			Pending
MacDermid Enthone Inc. 60	Advanced Solder Alloys For Electronic Interconnects	15286759	10/6/2016			Pending
MacDermid Enthone Inc. 61	METHOD FOR DIRECT METALLIZATION OF NON-CONDUCTING SUBSTRATES	11423474	6/12/2006			Pending
MacDermid Enthone Inc. 62	METHOD AND DEVICE FOR COATING SUBSTRATE SURFACES	12278256	12/15/2008			Pending
MacDermid Enthone Inc. 63	CORROSION PROTECTION OF BRONZES	12665908	8/9/2010			Pending
MacDermid Enthone Inc. 64	Electrolyte and method for deposition of matte metal layer	13003398	6/15/2011			Pending
MacDermid Enthone Inc. 65	Method for deposition of hard chrome layers	13125622	4/22/2011			Pending
MacDermid Enthone Inc. 66	Corrosion-protective wax composition containing polyaniline in a doped form and a liquid paraffin	13638442	1/9/2013			Pending

⁶⁰ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

⁶¹ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ⁶² Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

⁶³ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

⁶⁵ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ⁶⁴ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

⁶⁶ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc

MacDermid Enthone Inc. 77	MacDermid Enthone Inc. 76	MacDermid Enthone Inc. 75	MacDermid Enthone Inc. 74	MacDermid Enthone Inc. 73	MacDermid Enthone Inc. 72		MacDermid Enthone Inc. 71		MacDermid Enthone Inc. 70		MacDermid Enthone Inc. 69	MacDermid Enthone Inc. 68	MacDermid Enthone Inc. 67	Owner
Bismuth coating protection for copper	Water soluble brighteners for zinc and zinc alloy electrolytes	Electroless nickel cobalt phosphorous composition and plating process	Ductility agents for nickel-tungsten alloys	Copper Electrodeposition in Microelectronics	Electrodeposition of Copper	nanoparticles	Electrodeposition of silver with fluoropolymer	metal	Apparatus for electrochemical deposition of a	of a passivation layer	Aqueous solution and method for the formation	Process for filling vias in the microelectronics	Copper filling of through silicon vias	Title
09403900	09394839	08963999	09046869	15291340	15037267		14776879		14234080		14001360	13981974	13699910	Application No.
1/18/2000	9/13/1999	11/4/1997	3/24/1998	10/12/2016	5/17/2016		9/15/2015		1/24/2014		2/10/2014	1/8/2014	12/12/2012	Filing Date
6331201	6238542	6146702	6045682											Patent No.
12/18/2001	5/29/2001	11/14/2000	4/4/2000											Issue Date
Granted	Granted	Granted	Granted	Pending	Pending		Pending		Pending		Pending	Pending	Pending	Status

⁶⁹ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ⁷² Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc ⁷¹ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc ⁷⁰ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc ⁶⁸ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc ⁶⁷ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ⁷³ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc

⁷⁷ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc

⁷⁶ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ⁷⁵ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc

Очпет	Title	Application No.	Filing Date	Patent No.	Issue Date	Status
MacDermid Enthone Inc. 78	Printed circuit board manufacture	08939656	9/29/1997	6395329	5/28/2002	Granted
MacDermid Enthone Inc. 79	Process for selective deposition of osp coating	09383718	8/26/1999	6524644	2/25/2003	Granted
MacDermid Enthone Inc. 80	on copper, excluding deposition on gold Chemical commounds made of intrisically	09463453	4/17/2000	0856599	10/14/2003	Granted
	conductive polymers and metals	0 0		0 0 0 0) () () ()	
MacDermid Enthone Inc. 81	Method for coating workpieces	09786300	7/13/2001	6635165	10/21/2003	Granted
MacDermid Enthone Inc. 82	Process for metallizing a plastic surface	09831008	5/3/2001	6712948	3/30/2004	Granted
MacDermid Enthone Inc. 83	System for the electrodialytic regeneration of an	10092976	3/7/2002	6723218	4/20/2004	Granted
	electroless bath electrolyte					
MacDermid Enthone Inc. 84	Electroplating chemistry for the cu filling of submicron features of vlsi/ulsi interconnect	09716975	11/20/2000	6776893	8/17/2004	Granted
MacDermid Enthone Inc. 85	Process for the extended use of electrolytes	10148090	10/3/2002	6797141	9/28/2004	Granted
MacDermid Enthone Inc. 86	Process for the non-galvanic tin plating of	10129998	7/31/2002	6821323	11/23/2004	Granted
	copper or copper alloys					
MacDermid Enthone Inc. 87	Method for the deposition of a chromium alloy	10169959	10/3/2002	6837981	1/4/2005	Granted
MacDermid Enthone Inc. 88	Printed circuit board manufacture	10118417	4/8/2002	6860925	3/1/2005	Granted

⁸¹ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc 83 Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc ⁸² Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ⁸⁰ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ⁷⁹ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

88 Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc ⁸⁷ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ⁸⁶ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc

85 Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc ⁸⁴ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

Owner	Title	Application No.	Filing Date	Patent No.	Issue Date	Status
MacDermid Enthone Inc. 89	Copper bath composition for electroless and/or electrolytic filling of vias and trenches for integrated circuit fabrication	10358596	2/5/2003	6897152	5/24/2005	Granted
MacDermid Enthone Inc. 90	ADHESION PROMOTION IN PRINTED CIRCUIT BOARDS	10619198	7/14/2003	7232478	6/19/2007	Granted
MacDermid Enthone Inc. 91	CAPPING OF METAL INTERCONNECTS IN INTEGRATED CIRCUIT ELECTRONIC DEVICES	10867346	6/14/2004	7268074	9/11/2007	Granted
MacDermid Enthone Inc	COPPER ELECTRODEPOSITION IN MICROELECTRONICS	11272999	11/14/2005	7303992	12/4/2007	Granted
MacDermid Enthone Inc.	DEFECT REDUCTION IN ELECTRODEPOSITED COPPER FOR SEMICONDUCTOR APPLICATIONS	10091106	3/4/2002	7316772	1/8/2008	Granted
MacDermid Enthone Inc. 92	Cobalt and nickel electroless plating in microelectronic devices	11085304	3/21/2005	7332193	2/19/2008	Granted
MacDermid Enthone Inc. 93	Capping of metal interconnects in integrated circuit electronic devices	11/852,513	9/10/2007	7393781	7/1/2008	Granted
MacDermid Enthone Inc. 94	Defectivity and process control of electroless deposition in microelectronics applications	11230912	9/20/2005	7410899	8/12/2008	Granted
MacDermid Enthone Inc. 95	Method for treating laser-structured plastic surfaces	11102038	4/8/2005	7578888	8/25/2009	Granted

⁸⁹ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

⁹⁰ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

⁹¹ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

⁹³ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ⁹² Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

⁹⁴ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

⁹⁵ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc

Owner	Title	Application No.	Filing Date	Patent No.	Issue Date	Status
MacDermid Enthone Inc. 96	Method for etching non-conductive substrate	11554100	10/30/2006	7578947	8/25/2009	Granted
	surfaces					
MacDermid Enthone Inc. 97	Defectivity and process control of electroless	11243876	10/5/2005	7615491	11/19/2009	Granted
	deposition in microelectronics applications					
MacDermid Enthone Inc. 98	Insoluble anode	11279512	4/12/2006	7666283	2/23/2010	Granted
MacDermid Enthone Inc. 99	Copper metallization of through silicon via	12185641	8/4/2008	7670950	3/2/2010	Granted
MacDermid Enthone Inc. 100	Adhesion promotion in printed circuit boards	11759456	6/7/2007	7682432	3/23/2010	Granted
MacDermid Enthone Inc. 101	Manufacture of electroless cobalt deposition	11549775	6/7/2007	7704306	4/27/2010	Granted
	compositions for microelectronics applications					
MacDermid Enthone Inc. 102	Tin-silver solder bumping in electronics	11463355	8/9/2006	7713859	5/11/2010	Granted
	manufacture					
MacDermid Enthone Inc. 103	Organic solderability preservative comprising	11620857	1/8/2007	7794531	9/14/2010	Granted
	high boiling temperature alcohol					
MacDermid Enthone Inc. 104	Direct metallization of electrically non-	11756048	5/31/2007	7815785	10/19/2010	Granted
	conductive polyimide substrate surfaces					
MacDermid Enthone Inc. 105	Copper electrodeposition in microelectronics	11846385	8/28/2007	7815786	10/19/2010	Granted

⁹⁸ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc ⁹⁷ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ⁹⁹ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ⁹⁶ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ¹⁰¹ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc

¹⁰⁵ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc

¹⁰⁴ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

Owner	Title	Application No.	Filing Date	Patent No.	Issue Date	Status
MacDermid Enthone Inc.	Method for supplying a plating composition with deposition metal ion during a plating operation	11420339	5/25/2006	7846316	12/7/2010	Granted
MacDermid Enthone Inc. ¹⁰⁶	Process and electrolytes for deposition of metal layers	10678601	10/3/2003	7846503	12/7/2010	Granted
MacDermid Enthone Inc. 107	Metallic surface enhancement	11736647	4/18/2007	7883738	2/8/2011	Granted
MacDermid Enthone Inc. ¹⁰⁸	Copper deposition for filling features in manufacture of microelectronic devices	12446176	4/17/2009	7968455	6/28/2011	Granted
MacDermid Enthone Inc. 109	Anti-tarnish coatings	11944287	11/21/2007	7972655	7/5/2011	Granted
MacDermid Enthone Inc. 110	Surface preparation process for damascene copper deposition	12238139	9/25/2008	7998859	8/16/2011	Granted
MacDermid Enthone Inc. 111	Copper electrodeposition in microelectronics	10963369	10/12/2004	8002962	8/23/2011	Granted
MacDermid Enthone Inc. 112	Maintenance of metallization baths	11039088	1/19/2005	8057678	11/15/2011	Granted
MacDermid Enthone Inc. 113	ADHESION PROMOTION IN PRINTED CIRCUIT BOARDS	11759624	6/7/2007	8142840	3/27/2012	Granted
MacDermid Enthone Inc. 114	DEPOSITING A MATT METAL LAYER	12168680	7/7/2008	8192607	6/5/2012	Granted

¹¹⁰ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ¹⁰⁷ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ¹⁰⁶ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc ¹⁰⁸ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

¹¹⁴ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc ¹¹³ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ¹¹² Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

MacDermid Enthone Inc. 115 MacDermid Enthone Inc. 116 MacDermid Enthone Inc. 117	METHOD FOR REMOVING IMPURITIES FROM A METAL DEPOSITION PROCESS SOLUTION SELF ASSEMBLED MOLECULES ON IMMERSION SILVER COATINGS COMPOSITE COATINGS FOR WHISKER REDUCTION	Application No. 11563335 12268144 12254207	Filing Date 11/27/206 11/10/2008 10/20/2008	Patent No. 8202431 8216645 8226807	Issue Date 6/19/2012 7/10/2012 7/24/2012	Status Granted Granted Granted
MacDermid Enthone Inc. 117	COMPOSITE COATINGS FOR WHISKER REDUCTION	12254207	10/20/2008	8226807	7/24/2012	Granted
MacDermid Enthone Inc. 118	GALVANIC BATH AND PROCESS FOR DEPOSITING ZINC-BASED LAYERS	12617202	11/12/2009	8282806	10/9/2012	Granted
MacDermid Enthone Inc. 119	SILVER PLATING IN ELECTRONICS MANUFACTURE	10902398	7/29/2004	8349393	1/8/2013	Granted
MacDermid Enthone Inc. 120	DEPOSITION OF CONDUCTIVE POLYMER AND METALLIZATION OF NON-CONDUCTIVE SUBSTRATES	12440355	3/25/2009	8366901	2/5/2013	Granted
MacDermid Enthone Inc. 121	Method and composition for electrodeposition of copper in microelectronics with dipyridylbased levelers	12324335	11/26/2008	8388824	3/5/2013	Granted
MacDermid Enthone Inc. 122	Electrolyte Composition and Method for the Deposition of a Zinc-Nickel Alloy Layer on a Cast Iron Or Steel Substrate	11778011	7/13/2007	8435398	5/7/2013	Granted

¹¹⁵ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ¹¹⁶ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

¹¹⁸ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc

¹¹⁹ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

¹²¹ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ¹²⁰ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

¹²² Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc

Owner MacDermid Enthone Inc. 123	Title Conner electrodenosition in microelectronics	Application No.	Filing Date	Patent No. 8608933	\$10C/17/21	Status
MacDermid Enthone Inc. 123	Copper electrodeposition in microelectronics	13/214,525	8/22/2011	8608933	12/17/2013	1
MacDermid Enthone Inc. 124	Anti-tarnish coatings	13/176,411	7/5/2011	8703243	4/22/2014	ı —
MacDermid Enthone Inc. 125	Metallic surface enhancement	12596559	2/2/2010	8741390	6/3/2014	
MacDermid Enthone Inc. 126	Method and composition for electrodeposition of copper in microelectronics with dipyridyl-based levelers	13/785,946	3/5/2013	8771495	7/8/2014	
MacDermid Enthone Inc. 127	Cyanide free electrolyte composition for the galvanic deposition of a copper laver	13054048	4/18/2011	8808525	8/19/2014	
MacDermid Enthone Inc. 128	Composite coatings for whisker reduction	13/556,522	7/24/2012	8906217	12/9/2014	
MacDermid Enthone Inc. 129	Method for the deposition of a metal layer comprising a beta-amino acid	13382131	3/7/2012	8962070	2/24/2015	
MacDermid Enthone Inc. 130	Silver plating in electronics manufacture	13/735,779	1/7/2013	8986434	3/24/2015	
MacDermid Enthone Inc. 131	CHROMIUM-FREE PICKLE FOR PLASTIC SURFACES	12672980	8/12/2010	9023228	5/5/2015	
MacDermid Enthone Inc. 132	Adhesion promotion in printed circuit boards	13/431,560	3/27/2012	9040117	5/26/2015	

Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc ¹²⁴ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ¹²⁶ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ¹²⁵ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ¹²³ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

¹²⁸ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

¹²⁹ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

¹³² Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc ¹³¹ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ¹³⁰ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

Owner	Title	Application No.	Filing Date	Patent No.	Issue Date	Status
MacDermid Enthone Inc. ¹³³	SOLDERABILITY ENHANCEMENT BY SILVER IMMERSION PRINTED CIRCUIT BOARD MANUFACTURE	10099936	3/13/2002	9072203	6/30/2015	Granted
MacDermid Enthone Inc. ¹³⁴	IMMERSION TIN SILVER PLATING IN ELECTRONICS MANUFACTURE	12607375	10/28/2009	9175400	11/3/2015	Granted
MacDermid Enthone Inc. ¹³⁵	CYANIDE-FREE ELECTROLYTE COMPOSITION, AND METHOD FOR THE	12445049	10/13/2009	9212427	12/15/2015	Granted
	DEPOSITION OF SILVER OR SILVER ALLOY LAYERS ON SUBSTRATES					
MacDermid Enthone Inc. 136	ELECTROLYTIC DEPOSITION OF METAL-BASED COMPOSITE COATINGS COMPRISING NANO-PARTICLES	12747681	7/19/2010	9217205	12/22/2015	Granted
MacDermid Enthone Inc. ¹³⁷	Defect reduction in electrodeposited copper for semiconductor applications	11/971,061	1/8/2008	9222188	12/29/2015	Granted
MacDermid Enthone Inc. ¹³⁸	METHOD FOR THE POST-TREATMENT OF METAL LAYERS	13129300	7/25/2011	9222189	12/29/2015	Granted
MacDermid Enthone Inc. 139	BETA-AMINO ACID COMPRISING PLATING FORMULATION	14630268	2/24/2015	9249513	2/2/2016	Granted
MacDermid Enthone Inc. 140	ADHESION PROMOTION IN PRINTED CIRCUIT BOARDS	13558019	7/25/2012	9338896	5/10/2016	Granted

¹³⁴ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ¹³³ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

¹³⁵ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc

¹³⁶ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

¹³⁷ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

¹³⁹ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ¹³⁸ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

¹⁴⁰ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc

Owner	Title	Application No.	Filing Date	Patent No.	Issue Date	Status
MacDermid Enthone Inc. 141	COPPER ELECTRODEPOSITION IN	14108954	12/17/2013	9493884	11/15/2016	Granted
	MICROELECTRONICS	14250071	4/10/2014	0530775	155512	
MacDermid Enthone Inc. 142	PROCESS FOR ELECTROLESS COPPER DEPOSITION ON LASER-DIRECT	14350971	4/10/2014	9538665	1/3/2017	Granted TEN
	STRUCTURED SUBSTRATES) A
MacDermid Enthone Inc. 143	METHOD FOR DIRECT METALLIZATION	13636087	2/4/2013	9617644	4/11/2017	Granted
	OF NON-CONDUCTIVE SUBSTRATES					
MacDermid Enthone Inc. 144	Cyanide-free Electrolyte Composition and Method	14962863	12/8/2015	9657402	5/23/2017	Granted
MacDermid Enthone Inc.	Selective Plating of three dimensional surfaces	16201092	11/27/2018			Pending
	to produce					
MacDermid Enthone Inc. 145	Self Assembled molecules on immersion siver	13545030	7/10/2012	8323741	12/4/2012	Granted
	coat					
MacDermid Enthone Inc. 146	Method and Composition for electrodeposition	14325601	7/8/2014	9613858	4/4/2017	Granted
MacDermid Enthone Inc. 147	Electroplating composition Bath [Gold]	09069442	4/29/1998	6576114	6/10/2003	Granted
MacDermid Enthone Inc.	Etching of Plastic Using Acidic Solutions	15/667002	8/2/2017			Published
MacDamid Crapbics Colutions	Drinting Closure and Mathode for Dradinging	168116100	1/20/2001	67/0/52	6/1/200/	Crantad
LLC	Same	071144024	1/2//2001	0172700	0/1/2007	Cranco
MacDermid Graphics Solutions,	Processless Digitally Imaged Printing Plate	10/105898	3/25/2002	6806018	10/19/2004	Granted
LLC	Using Microspheres					
MacDermid Graphics Solutions,	UV Absorbing Support Layers & Flexographic	09/415811	10/11/1999	6413699	7/2/2002	Granted
LLC	Printing Elements Comprising Same					

¹⁴¹ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

¹⁴² Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

¹⁴³ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

¹⁴⁵ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc. ¹⁴⁴ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

¹⁴⁶ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

¹⁴⁷ Appropriate documentation to be filed with the USPTO to update owner name from Enthone Inc.

	Granted	//24/2007	/24/344	11/16/2004	10/99008/	Treatments to Photosensitive Printing Elements During Thermal Development	MacDermid Graphics Solutions, LLC
	Granted	12/6/2011	8071269	11/20/2007	11/986074	Compressible Flexographic Printing Plate Construction	MacDermid Graphics Solutions, LLC
	Granted	1/15/2008	7318994	10/14/2004	10/965315	Compressible Flexographic Printing Plate Construction	MacDermid Graphics Solutions, LLC
	Granted	6/19/2007	7232649	5/23/2006	11/439026	Method for Thermally Processing Photosensitive Printing Sleeves	MacDermid Graphics Solutions, LLC
	Granted	7/25/2006	7081331	11/12/2004	10/987624	Method for Thermally Processing Photosensitive Printing Sleeves	MacDermid Graphics Solutions, LLC
	Granted	7/3/2007	7237482	2/10/2005	11/055196	Flexo Processor	MacDermid Graphics Solutions, LLC
	Granted	2/20/2007	7179583	10/29/2004	10/977049	Edge Cure Prevention Composition and Process for Using the Same	MacDermid Graphics Solutions, LLC
	Granted	10/24/2006	7125650	7/20/2004	10/894979	Method for Bump Exposing Relief Image Printing Plates	MacDermid Graphics Solutions, LLC
	Granted	6/6/2006	7055429	4/23/2004	10/830560	Edge Cure Prevention Process	MacDermid Graphics Solutions, LLC
	Granted	12/26/2006	7152529	12/8/2005	11/297725	System for Thermal Development of Flexographic Printing Plates	MacDermid Graphics Solutions, LLC
	Granted	5/16/2006	7044055	4/30/2004	10/837107	System for Thermal Development of Flexographic Printing Plates	MacDermid Graphics Solutions, LLC
<u>L</u>	Granted	2/14/2006	6998218	3/29/2004	10/811763	Apparatus and Method for Thermally Developing Flexographic Printing Sleeves	MacDermid Graphics Solutions, LLC
l	Granted	5/9/2006	7041432	7/14/2004	10/891351	Apparatus and Method for Thermally Developing Flexographic Printing Elements	MacDermid Graphics Solutions, LLC
l	Granted	12/15/2009	7632625	5/25/2004	10/853342	Method of Preexposing Relief Image Printing Plate	MacDermid Graphics Solutions, LLC
PA	Granted	11/22/2005	6966259	1/9/2004	10/754297	Printing Sleeve with an Integrated Printing Surface	MacDermid Graphics Solutions, LLC
 TEN	Granted	4/9/2002	6367381	2/22/2000	09/507840	Laser Image Printing Plates Comprising A Multi-Layer Slip Film	MacDermid Graphics Solutions, LLC
 T	Granted	9/11/2007	RE39835	1/6/2004	10/752484	UV Absorbing Support Layers & Flexographic Printing Elements Comprising Same	MacDermid Graphics Solutions, LLC
	Status	Issue Date	Patent No.	Filing Date	Application No.	Title	Owner

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	Granted	8/5/2014	8795950	6/30/2010	12/826773	Method of Improving Print Performance in Flexographic Printing Plates	MacDermid Graphics Solutions, LLC
	Granted	3/29/2016	9298092	6/26/2014	14/315883	Method of Improving Print Performance in Flexographic Printing Plates	MacDermid Graphics Solutions, LLC
	Granted	7/23/2013	8492074	1/5/2011	12/984699	Method of Improving Print Performance in Flexographic Printing Plates	MacDermid Graphics Solutions, LLC
	Granted	7/2/2013	8476000	6/4/2010	12/794238	Method of Producing a Relief Image from a Liquid Photopolymer Resin	MacDermid Graphics Solutions, LLC
	Granted	6/25/2013	8470517	3/5/2012	13/411762	Method for Improving Print Performance in Flexographic Printing Plates	MacDermid Graphics Solutions, LLC
	Granted	4/17/2012	8158331	10/1/2009	12/571523	Method for Improving Print Performance in Flexographic Printing Plates	MacDermid Graphics Solutions, LLC
	Granted	8/1/2017	9720326	2/26/2010	12/660451	Method for Improving Print Performance in Flexographic Printing Plates	MacDermid Graphics Solutions, LLC
	Published			6/30/2017	15/638878	Method for Improving Print Performance in Flexographic Printing Plates	MacDermid Graphics Solutions, LLC
	Granted	9/16/2014	8833258	2/9/2009	12/367650	Means for Attaching a Printing Plate to a Printing Cylinder	MacDermid Graphics Solutions, LLC
	Granted	6/3/2014	8739701	7/31/2008	12/183461	Method and Apparatus for Thermal Processing of Photosensitive Printing Elements	MacDermid Graphics Solutions, LLC
	Granted	8/3/2010	7767383	8/8/2007	11/890827	Method of Pre-Exposing Relief Image Printing Plate	MacDermid Graphics Solutions, LLC
	Granted	5/12/2009	7531285	1/17/2006	11/333022	Method of Creating a Digital Mask for Flexographic Printing Elements In Situ	MacDermid Graphics Solutions, LLC
L	Granted	1/17/2012	8098270	3/30/2009	12/413753	Method of Creating a Digital Mask for Flexographic Printing Elements In Situ	MacDermid Graphics Solutions, LLC
l	Granted	6/30/2015	9069255	11/18/2009	12/620715	Carrier Sheet for a Photosensitive Printing Element	MacDermid Graphics Solutions, LLC
l	Granted	12/1/2009	7625691	11/30/2005	11/289814	Photopolymer Printing Form with Reduced Processing Time	MacDermid Graphics Solutions, LLC
	Granted	5/24/2011	7947427	5/21/2009	12/469721	Printing Element with an Integral Printing Surface	MacDermid Graphics Solutions, LLC
 TEN	Granted	4/10/2007	7202008	6/23/2005	11/159704	Thermal Development System and Method of Using the Same	MacDermid Graphics Solutions, LLC
 	Granted	6/13/2006	7060417	11/18/2004	10/992123	Edge Cure Prevention Process	MacDermid Graphics Solutions, LLC
	Status	Issue Date	Patent No.	Filing Date	Application No.	Title	Owner

Owner	Title	Application No.	Filing Date	Patent No.	Issue Date	Status
MacDermid Graphics Solutions, LLC	Photosensitive Resin Laminate and Thermal Processing of the Same	14/136547	12/20/2013	9086630	7/21/2015	Granted
MacDermid Graphics Solutions, LLC	Photosensitive Resin Laminate and Thermal Processing of the Same	13/030810	2/18/2011	8652761	2/18/2014	Granted TEN
MacDermid Graphics Solutions, LLC	Slip Film for Relief Image Printing Element	13/169296	6/27/2011	8771926	7/8/2014	Granted
MacDermid Graphics Solutions, LLC	Method of Controlling Surface Roughness of a Flexographic Printing Plate	14/081200	11/15/2013	9291891	3/22/2016	Granted
MacDermid Graphics Solutions, LLC	Method of Controlling Surface Roughness of a Flexographic Printing Plate	13/182533	7/14/2011	8632958	1/21/2014	Granted
MacDermid Graphics Solutions, LLC	Laminated Flexographic Printing Sleeves and Methods of Making the Same	13/205107	8/8/2011	8871431	10/28/2014	Granted
MacDermid Graphics Solutions, LLC	Improved Laminating Apparatus and Method of Using the Same	13/355769	1/23/2012	7557938	4/15/2014	Granted
MacDermid Graphics Solutions, LLC	Photosensitive Resin Laminate and Thermal Processing of the Same	14/016443	9/3/2013	9223218	12/29/2015	Granted
MacDermid Graphics Solutions, LLC	Photosensitive Resin Laminate and Thermal Processing of the Same	13/091466	4/21/2011	8551688	10/8/2013	Granted
MacDermid Graphics Solutions, LLC	Methods for Improving Print Performance of Flexographic Printing Elements	13/183558	7/15/2011	8669041	3/11/2014	Granted
MacDermid Graphics Solutions, LLC	Integrated Membrane Lamination and UV Exposure System and Method of Using the Same	13/372060	2/13/2012	8524442	9/3/2013	Granted
MacDermid Graphics Solutions, LLC	Method of Improving Print Performance in Flexographic Printing Plates	14/302512	6/12/2014	9046778	6/2/2015	Granted
MacDermid Graphics Solutions, LLC	Method of Improving Print Performance in Flexographic Printing Plates	13/595473	8/27/2012	8790864	7/29/2014	Granted
MacDermid Graphics Solutions, LLC	Clean Flexographic Printing Plate and Method of Making the Same	13/409374	3/1/2012	9114601	8/25/2015	Granted
MacDermid Graphics Solutions, LLC	Liquid Platemaking with Laser Engraving	13/467325	5/9/2012	0609606	8/4/2015	Granted
MacDermid Graphics Solutions, LLC	Liquid Platemaking Process	13/477556	5/22/2012	8735049	5/27/2014	Granted
MacDermid Graphics Solutions, LLC	Method of Improving Surface Cure in Digital Flexographic Printing Plates	14/328857	7/11/2014	9329480	5/3/2016	Granted

	Pending			4/27/2017	15/498844	Improved Method of Making a Flexographic Printing Plate	MacDermid Graphics Solutions, LLC
	Published			4/12/2017	15/485504	Method of Improving Light Stability of Flexographic Printing Plates Featuring Flat Top Dots	MacDermid Graphics Solutions, LLC
	Granted	10/23/2018	10108087	3/11/2016	15/067622	Method of Improving Light Stability of Flexographic Printing Plates Featuring Flat Top Dots	MacDermid Graphics Solutions, LLC
	Granted	8/22/2017	9740103	11/9/2015	14/935963	Method and Apparatus for Producing Liquid Flexographic Printing Plates	MacDermid Graphics Solutions, LLC
	Granted	11/27/2018	10139730	4/21/2017	15/493498	Method and Apparatus for Producing Liquid Flexographic Printing Plates	MacDermid Graphics Solutions, LLC
	Granted	3/27/2018	9925757	2/10/2016	15/040617	Customizable Printing Plates and Method of Making the Same	MacDermid Graphics Solutions, LLC
	Granted	6/13/2017	9678429	8/18/2015	14/829163	Method of Creating Hybrid Printing Dots in a Flexographic Printing Plate	MacDermid Graphics Solutions, LLC
	Granted	9/12/2017	9757919	8/20/2015	14/830833	Carrier Sheet and Method of Using the Same	MacDermid Graphics Solutions, LLC
	Granted	7/11/2017	9703201	4/22/2015	14/693062	Method of Making Relief Image Printing Plates	MacDermid Graphics Solutions, LLC
	Granted	8/22/2017	9740099	11/12/2014	14/539171	Flexographic Printing Plate with Improved Cure Efficiency	MacDermid Graphics Solutions, LLC
	Granted	2/9/2016	9256129	2/19/2014	14/183948	Method for Creating Surface Texture on Flexographic Printing Elements	MacDermid Graphics Solutions, LLC
L	Granted	12/22/2015	9217928	8/13/2014	14/458659	Clean Flexographic Printing Plates and Method of Making the Same	MacDermid Graphics Solutions, LLC
	Granted	7/17/2018	10025183	1/22/2014	14/160799	Photosensitive Resin Composition	MacDermid Graphics Solutions, LLC
	Granted	5/16/2017	9649786	8/13/2013	13/965537	Apparatus for Thermal Processing of Flexographic Printing Elements	MacDermid Graphics Solutions, LLC
 • Ρ Δ	Granted	5/26/2015	9040226	5/13/2013	13/892406	Method of Improving Print Performance in Flexographic Printing Plates	MacDermid Graphics Solutions, LLC
 TEN	Granted	8/19/2014	8808968	8/22/2012	13/591375	Method of Improving Surface Cure in Digital Flexographic Printing Plates	MacDermid Graphics Solutions, LLC
	Granted	9/5/2017	9751353	3/31/2016	15/086402	Method of Improving Surface Cure in Digital Flexographic Printing Plates	MacDermid Graphics Solutions, LLC
	Status	Issue Date	Patent No.	Filing Date	Application No.	Title	Owner

Owner	Title	Application No.	Filing Date	Patent No.	Issue Date	Status
MacDermid Graphics Solutions, LLC	Method of Producing a Relief Image from a Liquid Photopolymer Resin	15/484314	4/11/2017			Published
MacDermid Graphics Solutions, LLC	Flexographic Printing Plate with Improved Storage Stability	15/590068	5/9/2017			Pending
MacDermid Graphics Solutions, LLC ¹⁴⁸	Laser imaged printing plates	09898152	7/3/2001	6916596	7/12/2005	Granted
MacDermid Graphics Solutions, LLC ¹⁴⁹	LASER IMAGED PRINTING PLATES	09921589	8/3/2001	6756181	6/29/2004	Granted
MacDermid Graphics Solutions, LLC ¹⁵⁰	LASER IMAGED PRINTING PLATES	10153946	5/23/2002	6605410	8/12/2003	Granted
MacDermid Graphics Solutions, LLC ¹⁵¹	Processless digitally imaged photopolymer elements using microspheres	10/768,799	1/30/2004	6989220	1/24/2006	Granted
MacDermid Graphics Solutions, LLC ¹⁵²	AQUEOUS DEVELOPABLE PHOTOSENSITIVE POLYURETHANE-	09535353	3/24/2000	6423472	7/23/2002	Granted
MacDermid Graphics Solutions, LLC ¹⁵³	METHACKYLATE COMPOSITE RELIEF IMAGE PRINTING PLATES	09417043	10/12/1999	6312872	11/6/2001	Granted
MacDermid Graphics Solutions, LLC ¹⁵⁴	Laser Imaged Printing Plates	15608210	5/30/2017			Pending
MacDermid Graphics Solutions, LLC ¹⁵⁵	Method of Improving Print Performance in Flexographic Printing Plates	15463379	3/20/2017			Pending

¹⁵⁴ Appropriate documentation to be filed with the USPTO to update owner name from MacDermid Printing Solutions, LLC 153 Appropriate documentation to be filed with the USPTO to update owner name from MacDermid Printing Solutions, LLC ¹⁵¹ Appropriate documentation to be filed with the USPTO to update owner name from MacDermid Printing Solutions, LLC ¹⁴⁹ Appropriate documentation to be filed with the USPTO to update owner name from MacDermid Printing Solutions, LLC ¹⁴⁸ Appropriate documentation to be filed with the USPTO to update owner name from MacDermid Printing Solutions, LLC 152 Appropriate documentation to be filed with the USPTO to update owner name from MacDermid Printing Solutions, LLC ¹⁵⁰ Appropriate documentation to be filed with the USPTO to update owner name from MacDermid Printing Solutions, LLC

155 Appropriate documentation to be filed with the USPTO to update owner name from MacDermid Printing Solutions, LLC

Owner	Title	Application No.	Filing Date	Patent No.	Issue Date	Status
MacDermid Graphics Solutions, LLC ¹⁵⁶	Method of Improving Print Performance in Flexographic Printing Plates	15463341	3/20/2017			Pending
MacDermid Graphics Solutions, LLC ¹⁵⁷	Method of Making a Flexographic Printing Plate	15224979	8/1/2016			Pending
MacDermid Graphics Solutions,	Method for Creating Surface Texture on	14985638	12/31/2015			Pending
LLC	Flexographic Printing Elements	1 10010	11/10/2011			=
MacDermid Graphics Solutions, LLC ¹⁵⁸	Apparatus for Thermal Processing of Flexographic Printing Elements	14937267	11/10/2015			Pending
MacDermid Graphics Solutions, LLC ¹⁵⁹	Laminating Apparatus and Method of Using the Same	14191529	2/27/2014			Pending
MacDermid Graphics Solutions, LLC ¹⁶⁰	Loading/Unloading System for Printing Plates	13653916	10/17/2012			Pending
MacDermid Graphics Solutions, LLC ¹⁶¹	Biodegradable Film for Flexographic Printing Plate Manufacture and Method of Using the Same	12939388	11/4/2010			Pending
MacDermid Graphics Solutions, LLC ¹⁶²	Method of Controlling Surface Roughness of a Flexographic Printing Plate	12348981	1/6/2009			Pending
MacDermid Graphics Solutions, LLC ¹⁶³	Apparatus and Method for Thermally Developing Flexographic Printing Elements	12267642	11/10/2008			Pending

Appropriate documentation to be filed with the USPTO to update owner name from MacDermid Printing Solutions, LLC ¹⁶² Appropriate documentation to be filed with the USPTO to update owner name from MacDermid Printing Solutions, LLC Appropriate documentation to be filed with the USPTO to update owner name from MacDermid Printing Solutions, LLC ¹⁵⁷ Appropriate documentation to be filed with the USPTO to update owner name from MacDermid Printing Solutions, LLC 156 Appropriate documentation to be filed with the USPTO to update owner name from MacDermid Printing Solutions, LLC ¹⁶⁰ Appropriate documentation to be filed with the USPTO to update owner name from MacDermid Printing Solutions, LLC ¹⁵⁹ Appropriate documentation to be filed with the USPTO to update owner name from MacDermid Printing Solutions, LLC ¹⁵⁸ Appropriate documentation to be filed with the USPTO to update owner name from MacDermid Printing Solutions, LLC

Owner	apple	Application No.	Filing Date	Patent No.	Issue Date	Status
MacDermid Graphics Solutions, LLC ¹⁶⁴	Apparatus for thermal processing of Flexographic Printing	15485336	4/12/2017			Pending
MacDermid Graphics Solutions, LLC	SLIP FILM COMPOSITIONS CONTAINING LAYERED SILICATES	10946937	9/22/2004	7736836	6/15/2010	Granted
MacDermid Graphics Solutions, LLC ¹⁶⁵	Method of Making Relief Image Printing Elements	15145230	5/3/2016	100336956	7/31/2018	Granted
MacDermid Offshore Solutions, LLC	Hydraulic Fluid Compositions	14/017786	9/4/2013	8809241	8/19/2014	Granted
MacDermid Offshore Solutions, LLC	Hydraulic Fluid Compositions	13/044613	3/10/2011	8563484	10/22/2013	Granted
MacDermid Offshore Solutions, LLC	Thermally Stable Subsea Control Hydraulic Fluid Compositions	14/157928	1/17/2014	9458408	10/4/2016	Granted
MacDermid Offshore Solutions, LLC	Thermally Stable Subsea Control Hydraulic Fluid Compositions	12/173284	7/15/2008	8759265	6/24/2014	Granted
MacDermid Offshore Solutions, LLC	Environmental Subsea Control Hydraulic Fluid Compositions	12/549579	8/28/2009	8575077	11/5/2013	Granted
MacDermid Offshore Solutions, LLC	Thermally Stable Subsea Control Hydraulic Fluid Compositions	12/469337	5/20/2009	8633141	1/21/2014	Granted
MacDermid Offshore Solutions, LLC	Thermally Stable Subsea Control Hydraulic Fluid Compositions	14/041669	9/30/2013	9096812	8/4/2015	Granted
MacDermid Offshore Solutions, LLC	Composition for Removing Scale Deposits	13/475030	5/18/2012	9145508	9/29/2015	Granted
MacDermid, Incorporated	Method for Enhancing the Solderability of a Surface	13/463087	5/3/2012	RE45842	1/12/2016	Granted
MacDermid, Incorporated	Method for Enhancing the Solderability of a Surface	13/463110	5/3/2012	RE45881	2/9/2016	Granted
MacDermid, Incorporated	Method for Enhancing the Solderability of a Surface	09/251641	2/17/1999	6200451	3/13/2001	Granted
MacDermid, Incorporated	Method for Enhancing the Solderability of a Surface	10/341859	1/14/2003	6905587	6/14/2005	Granted
MacDermid, Incorporated	Method for Enhancing the Solderability of a Surface	13/371848	2/13/2012	RE45297	12/23/2014	Granted

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Owner	Title	Application No.	Filing Date	Patent No.	Issue Date	Status
MacDermid, Incorporated	Method for Enhancing the Solderability of a Surface	10/456329	6/6/2003	7267259	9/11/2007	Granted
MacDermid, Incorporated	Method for Enhancing the Solderability of a Surface	09/698370	10/26/2000	6444109	9/3/2002	Granted
MacDermid, Incorporated	Method for Enhancing the Solderability of a Surface	09/821205	3/29/2001	6544397	4/8/2003	Granted
MacDermid, Incorporated	Re-Examination of Ferrier 5,733,599 (MacDermid) METHOD FOR ENHANCING THE SOLDERABILITY OF A SURFACE	90/012,575	9/14/2012	5733599	3/7/2013	Granted
MacDermid, Incorporated/Chemtech Systems	Nickel pH Adjustment Method and Apparatus	12/858887	8/18/2010	8980068	3/17/2015	Granted
Napp Systems, Inc.	High Performance, Photoimageable Resin Composition & Printing Plates Prepared Therefrom	09/823904	3/30/2001	6579664	6/17/2003	Granted
Napp Systems, Inc.	High Performance Photoimageable Resin Composition & Printing Plates Prepared Therefrom	10/386315	3/11/2003	6780566	8/24/2004	Granted
Napp Systems, Inc.	Apparatus & Method For The Enhanced Imagewise Exposure of a Photosensitive Material	09/382214	8/24/1999	6262825	7/17/2001	Granted
Napp Systems, Inc.	Solvent-Developable Printing Formulations with Improved Processing Characteristics	09/624104	7/24/2000	6551756	4/22/2003	Granted
Napp Systems, Inc.	Highly Reflective Substrates for the Digital Imaging of Photopolymer Printing Plates	10/462977	6/16/2003	7005232	2/28/2006	Granted
Napp Systems, Inc.	Highly Reflective Substrates for the Digital Imaging of Photopolymer Printing Plates	11/267435	11/4/2005	7083896	8/1/2006	Granted
Napp Systems, Inc.	High Performance Water-Based Primer	10/805769	3/22/2004	7217756	5/15/2007	Granted
Napp Systems, Inc.	Apparatus for the Rapid Development of Photosensitive Printing Elements	10/970881	10/22/2004	7156630	1/2/2007	Granted
Napp Systems, Inc.	Flexo Cushion	12/037429	2/26/2008	8943969	2/3/2015	Granted

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